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(12) **United States Design Patent**  
**Chiang et al.**

(10) **Patent No.:** **US D617,748 S**  
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(54) **HEAT DISSIPATION APPARATUS**

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(\*\*) Term: **14 Years**

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(30) **Foreign Application Priority Data**

Jun. 2, 2009 (CN) ..... 2009 3 0305221

(51) **LOC (9) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/179**

(58) **Field of Classification Search** ..... D13/179;  
165/80.3, 104.33, 151, 122, 185; 257/706,  
257/707, 718-722; 361/687, 695, 697, 700,  
361/702, 704, 709, 710, 711, 719

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a heat dissipation apparatus, as shown.

**DESCRIPTION**

FIG. 1 is a perspective view of a heat dissipation apparatus showing our new design.

FIG. 2 is a front elevational view thereof.

FIG. 3 is a rear elevational view thereof.

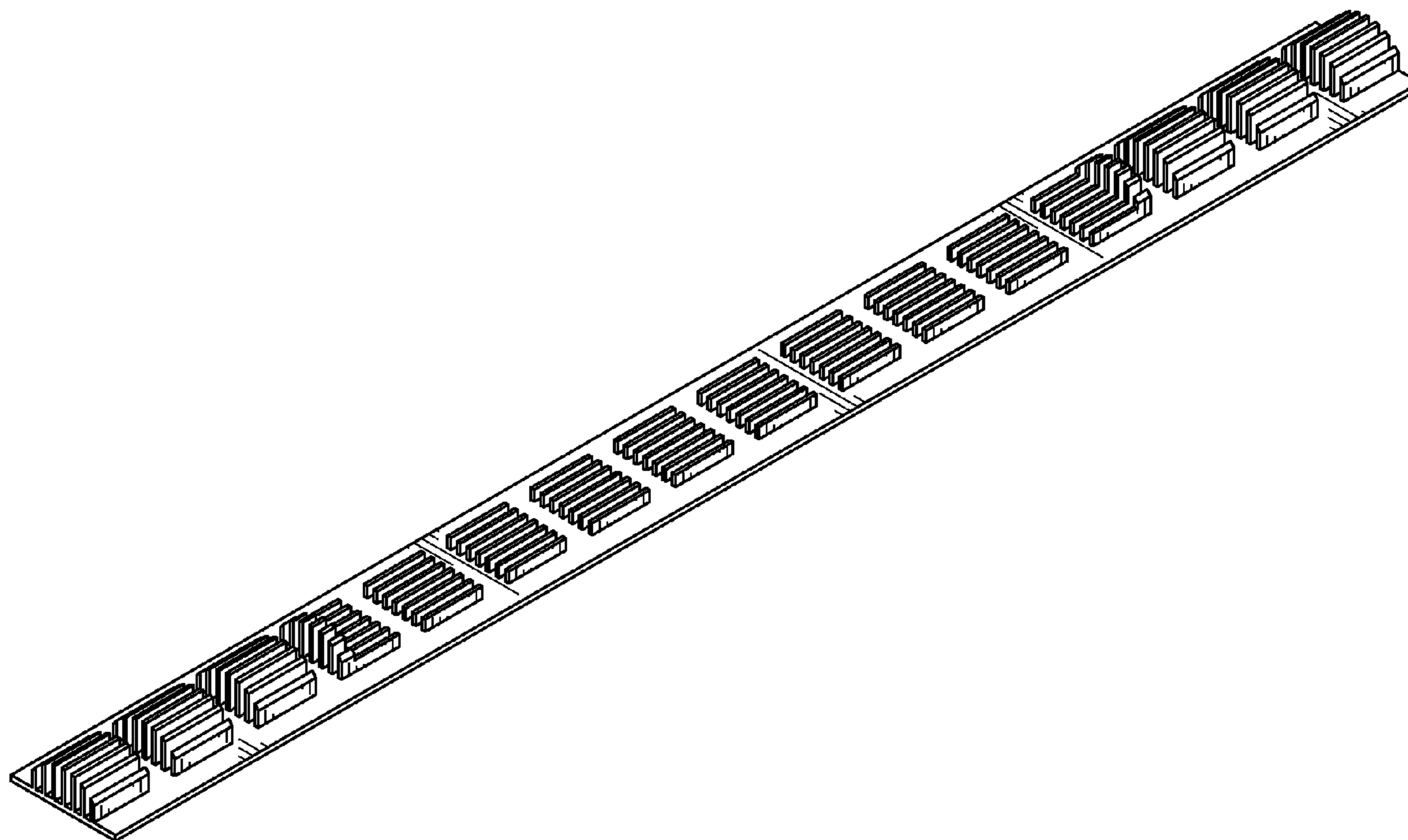
FIG. 4 is a left-side, elevational view thereof.

FIG. 5 is a right-side, elevational view thereof.

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

**1 Claim, 7 Drawing Sheets**



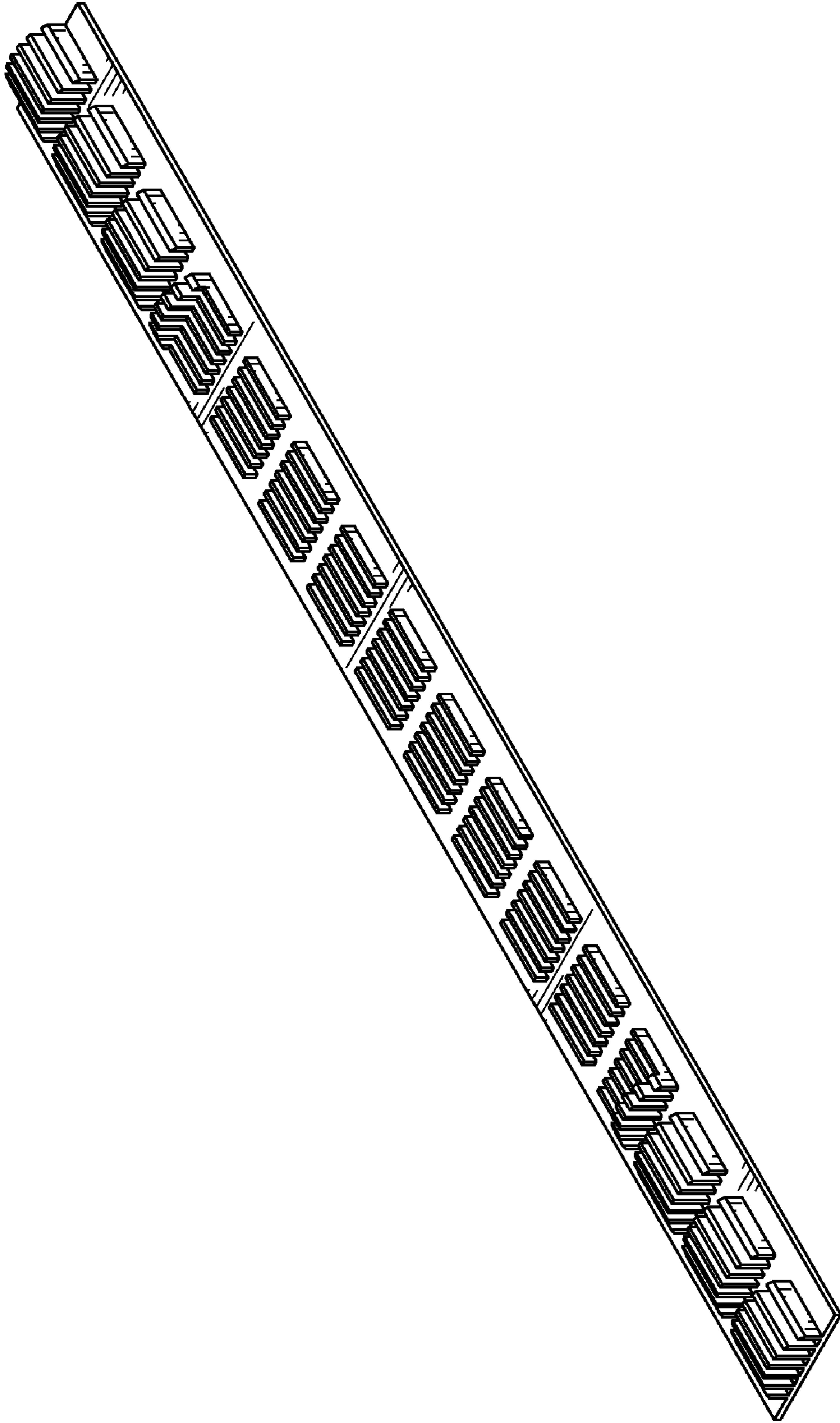


FIG. 1

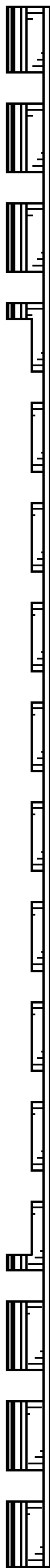


FIG. 2

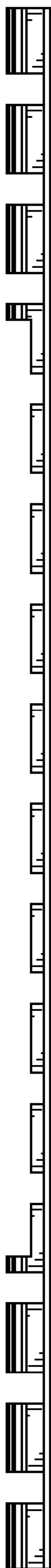


FIG. 3

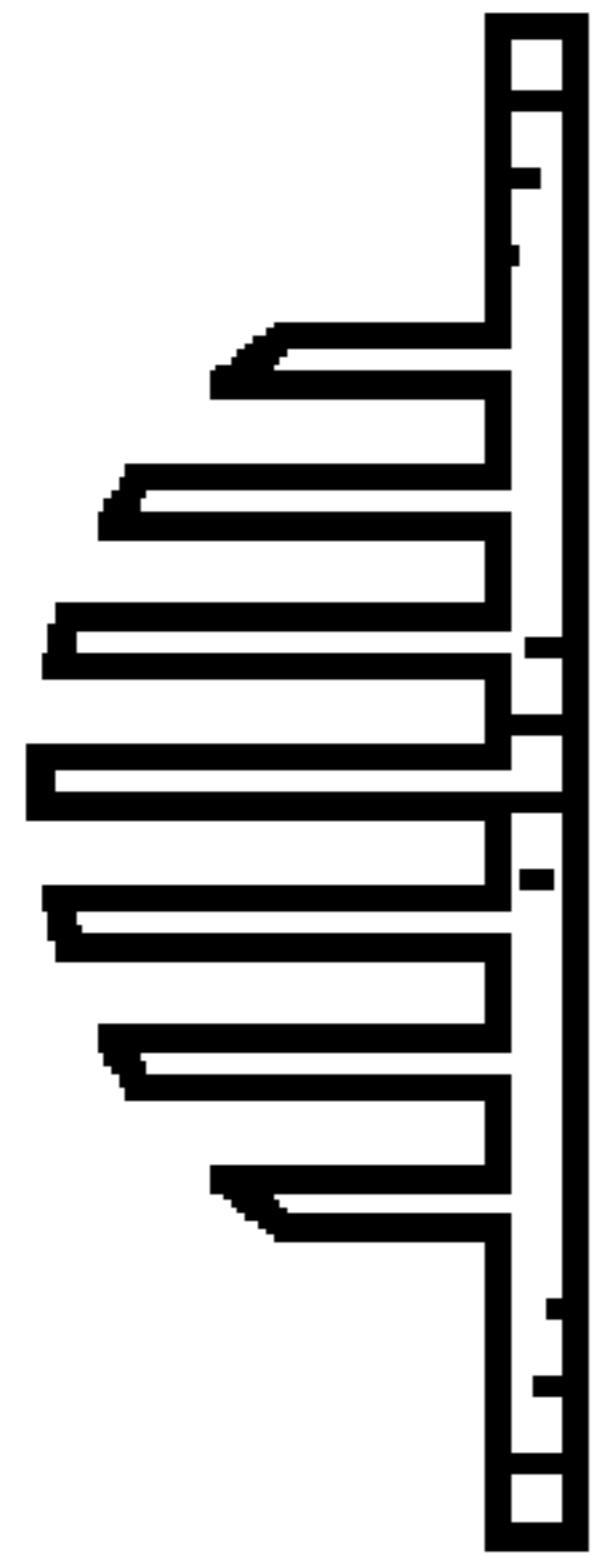


FIG. 4

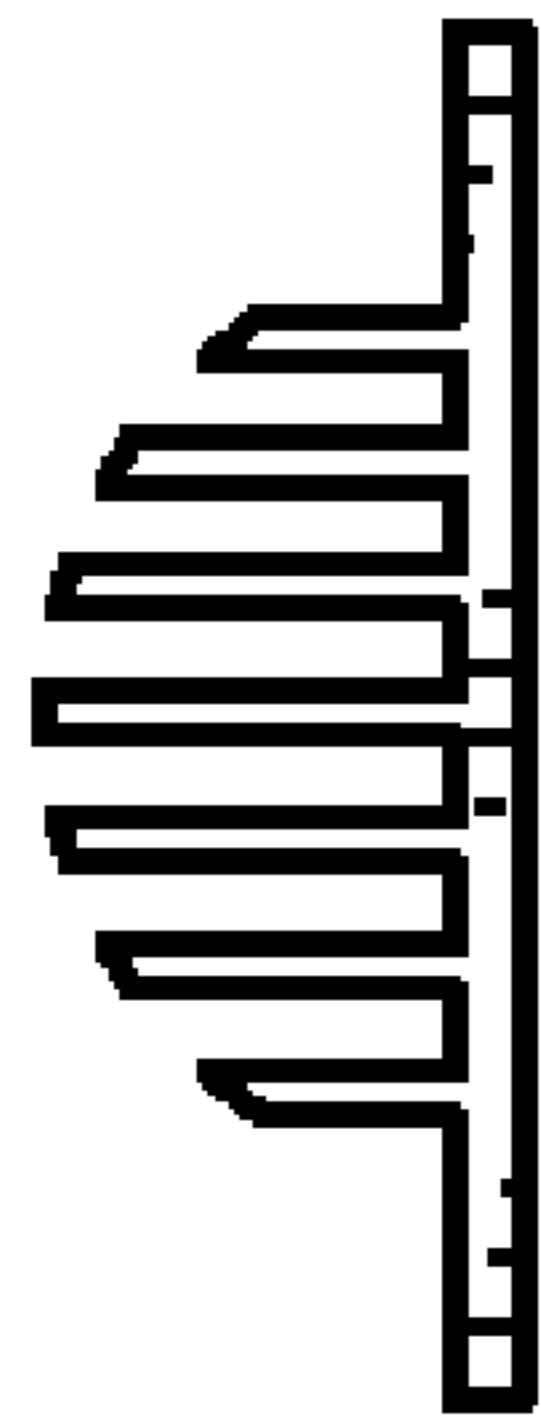


FIG. 5

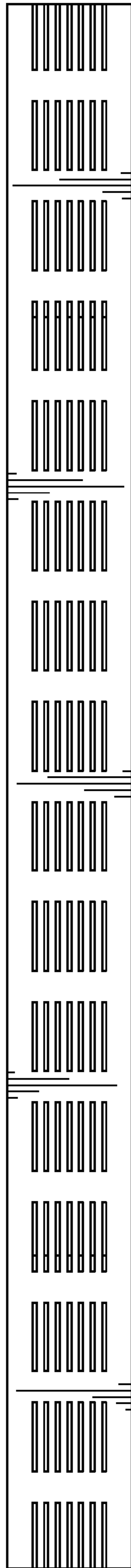


FIG. 6

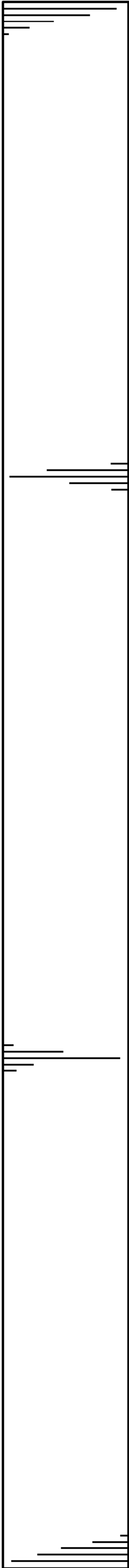


FIG. 7